1379114-1 ACTIVE

MQS

TE Internal #: 1379114-1

PCB Mount Header, Vertical, Wire-to-Board, 12 Position, 2.54 mm [. 1 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder,

Signal, Black

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Signal Header











PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Wire-to-Board

Number of Positions: 12

Number of Rows: 2

All Signal Header (240)

Features

Product Type Features

Mixed & Hybrid Header	No
Connector Shape	Rectangular
PCB Connector Type	PCB Mount Header
Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Configuration Features	
Number of Signal Positions	12
Number of Sections	1
PCB Mount Orientation	Vertical
Number of Positions	12



Number of Rows	2
Electrical Characteristics	
Operating Voltage	12 VDC
Nominal Voltage Architecture	12 V
Body Features	
Connector & Keying Code	1
Primary Product Color	Black
Contact Features	
Contact Size	.63mm
Mating Tab Width	.63 mm[.025 in]
Mating Tab Thickness	.63 mm[.025 in]
Contact Mating Area Plating Material	Tin (Sn)
Contact Type	Tab
Termination Features	
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Panel Mount Feature	With
Mating Retention Type	Locking Interface
Mounting Holes	Without
Mating Retention	With
PCB Mount Retention Type	Boardlock
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Panel Mount
Mating Alignment	With
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Connector Width	17 mm[.669 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Profile Height from PCB	20.3 mm[.799 in]
Connector Length	40.3 mm[1.587 in]



Usage Conditions

Operating Temperature (Max)	65 °C, 70 °C, 75 °C, 80 °C, 85 °C[149 °F][158 °F][167 °F][176 °F][185 °F]
Operating Temperature Range	-40 - 85 °C[-40 - 185 °F]
Operation/Application	
Shielded	No

Packaging Features

Circuit Application

Packaging Quantity	648
Packaging Method	Tray

Signal

Other

Interface Number	208-15544	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Compatible Parts







Customers Also Bought



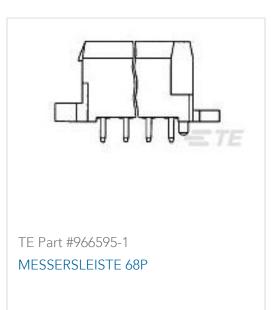
















Documents

Product Drawings

12pos MQS .63 header 180deg

English

CAD Files

3D PDF

PCB Mount Header, Vertical, Wire-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Signal, Black



3D

Customer View Model

ENG_CVM_CVM_1379114-1_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1379114-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1379114-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Product Specification

French

Product Specification

French